

WSF50N10

N-Ch MOSFET

General Description

The WSF50N10 is the highest performance trench N-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF50N10 meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

Product Summery

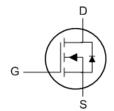
BV _{DSS}		I _D
100V	22mΩ	50A

Applications

- High Frequency Point-of-Load Synchronous
 Buck Converter
- Networking DC-DC Power System
- Load Switch

TO-252 Pin Configuration





Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage 100		V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	50	А
I₀@T₀=100°℃	Continuous Drain Current, V _{GS} @ 10V ¹	25	А
I _D @T _A =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	6.7	A
I _D @T _A =70℃	Continuous Drain Current, V _{GS} @ 10V ¹	5.3	А
I _{DM}	Pulsed Drain Current ² 160		А
EAS	Single Pulse Avalanche Energy ³	81	mJ
I _{AS}	Avalanche Current	18	A
P _D @T _C =25℃	Total Power Dissipation ⁴	83	W
P _D @T _A =25℃	Total Power Dissipation ⁴ 33		W
T _{STG}	Storage Temperature Range -55 to 150		°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{eja}	Thermal Resistance Junction-ambient ¹		50	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹		1.5	°C/W

Absolute Maximum Ratings



N-Ch MOSFET

Electrical Characteristics (T_J=25⁻¹C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I _D =250uA	100			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\!{\rm C}$, I_D=1mA		0.098		V/℃
В	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =20A		22	28	0
R _{DS(ON)}		V _{GS} =4.5V , I _D =15A		24	32	mΩ
V _{GS(th)}	Gate Threshold Voltage		1.0	2.0	3.0	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_{D}=250$ uA		-5.52		mV/℃
		V _{DS} =80V , V _{GS} =0V , T _J =25℃			10	
I _{DSS}	Drain-Source Leakage Current	V _{DS} =80V , V _{GS} =0V , T _J =55℃			100	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm20V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =20A		25.7		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.0	1.2	Ω
Qg	Total Gate Charge (10V)			50	65	
Q _{gs}	Gate-Source Charge			8	14	nC
Q _{gd}	Gate-Drain Charge			10	18	
T _{d(on)}	Turn-On Delay Time	V _{DD} =30V , V _{GS} =10V,I _D =20A		18	33	
Tr	Rise Time			9	17	
T _{d(off)}	Turn-Off Delay Time			56	101	ns
T _f	Fall Time			14	26	
Ciss	Input Capacitance			2450		
C _{oss}	Output Capacitance	V _{DS} =30V , V _{GS} =0V , f=1MHz		150		pF
C _{rss}	Reverse Transfer Capacitance			85		

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy⁵	V _{DD} =25V , L=0.1mH , I _{AS} =18A	80			mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I _S	Continuous Source Current ^{1,6}	$V_G = V_D = 0V$, Force Current			20	А
I _{SM}	Pulsed Source Current ^{2,6}				45	А
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =20A , T _J =25℃			1.3	V
t _{rr}	Reverse Recovery Time	lF=20A , dl/dt=100A/µs , Tյ=25℃		40		nS
Qrr	Reverse Recovery Charge			83		nC

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3. The EAS data shows Max. rating . The test condition is $V_{\text{DD}}\text{=}25\text{V}, V_{\text{GS}}\text{=}10\text{V}, \text{L=}0.1\text{mH}, \text{I}_{\text{AS}}\text{=}18\text{A}$

4.The power dissipation is limited by 150 $^\circ\!\!\!\mathrm{C}$ junction temperature

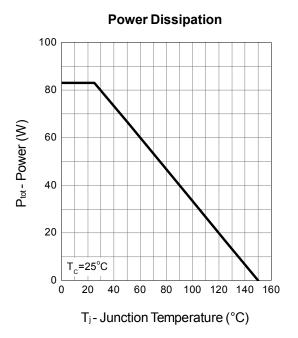
5. The Min. value is 100% EAS tested guarantee.

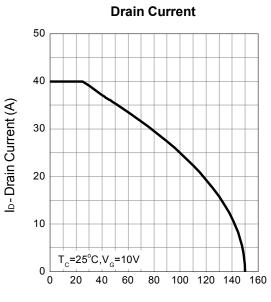
6. The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.



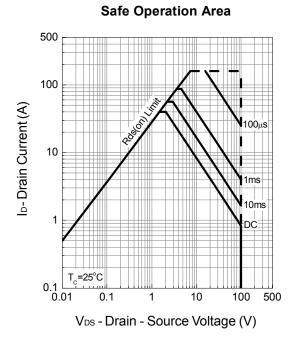
N-Ch MOSFET

Typical Characteristics

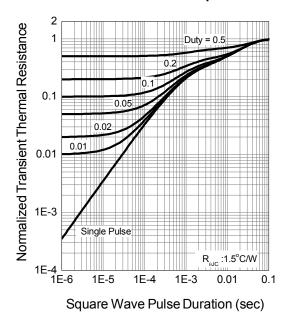




T_j - Junction Temperature



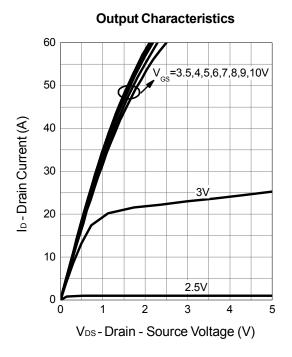
Thermal Transient Impedance



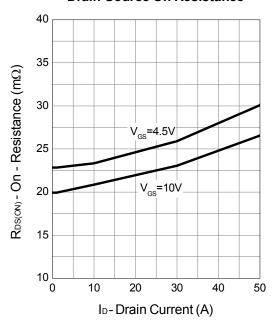


N-Ch MOSFET

Typical Characteristics



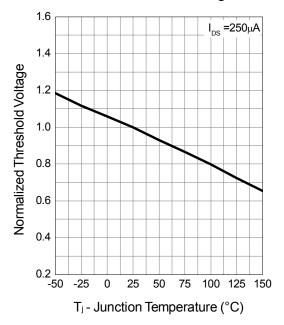
Drain-Source On Resistance



36 I_{DS}=20A 33 R_{DS(ON)} - On - Resistance (mΩ) 30 27 24 21 18 └─ 2 3 4 5 6 7 8 9 10 VGS - Gate - Source Voltage (V)

Gate-Source On Resistance

Gate Threshold Voltage





WSF50N10

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Typical Characteristics

4000

3500

3000

2500

2000

1500

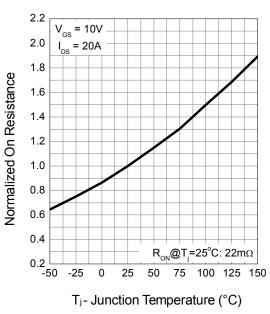
1000

500

0 Crs

8

C - Capacitance (pF)

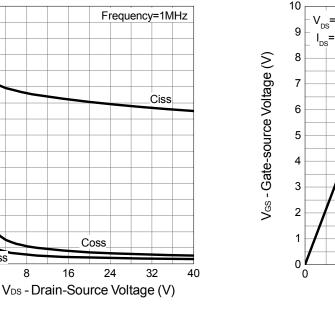


Capacitance

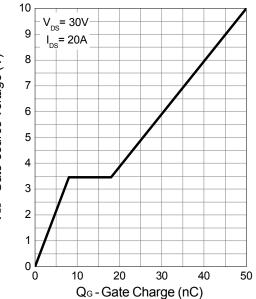
Drain-Source On Resistance

100 T_i=150°C Is - Source Current (A) 10 T,=25°C 1 0.1 └─ 0.0 0.2 0.6 0.8 1.0 1.2 1.4 0.4 Vsp - Source - Drain Voltage (V)

Source-Drain Diode Forward



Gate Charge





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